FCP260N60E / FCPF260N60E

600V N-Channel MOSFET

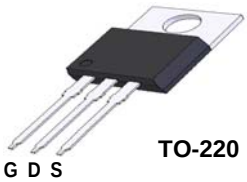
Features

- 650V @T_J = 150°C
- Max. $R_{DS(on)}$ = 260mΩ
- Ultra Low Gate Charge (Typ. Q_g = 48nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 129pF)
- 100% Avalanche Tested

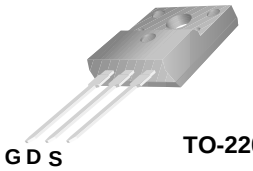
Description

SuperFET®II is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

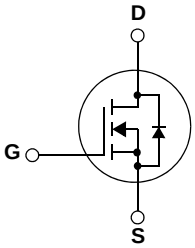
This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET®II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



TO-220



TO-220F



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			FCP260N60E	FCPF260N60E	Units
V_{DSS}	Drain to Source Voltage			600		V
V_{GSS}	Gate to Source Voltage	- DC		±20		V
		- AC	(f > 1Hz)	±30		V
I_D	Drain Current	-Continuous (T_C = 25°C)		15	15*	A
		-Continuous (T_C = 100°C)		9.5	9.5*	
I_{DM}	Drain Current	- Pulsed	(Note 1)	45	45*	A
E_{AS}	Single Pulsed Avalanche Energy		(Note 2)	292.5		mJ
I_{AR}	Avalanche Current		(Note 1)	3.0		A
E_{AR}	Repetitive Avalanche Energy		(Note 1)	1.56		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns
	MOSFET dv/dt			100		
P_D	Power Dissipation	(T_C = 25°C)		156	36	W
		- Derate above 25°C		1.25	0.29	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range			-55 to +150		°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCP260N60E	FCPF260N60E	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.8	3.5	°C/W
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	0.5	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP260N60E	FCP260N60E	TO-220	-	-	50
FCPF260N60E	FCPF260N60E	TO-220F	-	-	50

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0V, I_D = 10mA, T_J = 25°C	600	-	-	V
		V_{GS} = 0V, I_D = 10mA, T_J = 150°C	650	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 10mA, Referenced to 25°C	-	0.67	-	V/°C
BV_{DS}	Drain-Source Avalanche Breakdown Voltage	V_{GS} = 0V, I_D = 15A	-	700	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 480V, V_{GS} = 0V	-	-	1	μA
		V_{DS} = 480V, T_C = 125°C	-	-	10	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	2.5	-	3.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10V, I_D = 7.5A	-	0.22	0.26	Ω
g_{FS}	Forward Transconductance	V_{DS} = 20V, I_D = 7.5A	-	15.5	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V f = 1MHz	-	1880	2500	pF
C_{oss}	Output Capacitance		-	1330	1770	pF
C_{rss}	Reverse Transfer Capacitance		-	85	130	pF
C_{oss}	Output Capacitance	V_{DS} = 380V, V_{GS} = 0V, f = 1.0MHz	-	32	-	pF
C_{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 480V, V_{GS} = 0V	-	129	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 380V, I_D = 7.5A V_{GS} = 10V (Note 4)	-	48	62	nC
Q_{gs}	Gate to Source Gate Charge		-	7.4	-	nC
Q_{gd}	Gate to Drain “Miller” Charge		-	17	-	nC
ESR	Equivalent Series Resistance	Drain open	-	5.8	-	Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 380V, I_D = 7.5A V_{GS} = 10V, R_G = 4.7Ω (Note 4)	-	20	50	ns
t_r	Turn-On Rise Time		-	11	32	ns
$t_{d(off)}$	Turn-Off Delay Time		-	89	188	ns
t_f	Turn-Off Fall Time		-	13	36	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	15	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	45	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_{SD} = 7.5A	-	-	1.2	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_{SD} = 7.5A dI_F/dt = 100A/μs	-	270	-	ns
Q_{rr}	Reverse Recovery Charge		-	3.6	-	μC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS} = 3A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. I_{SD} ≤ 7.5A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

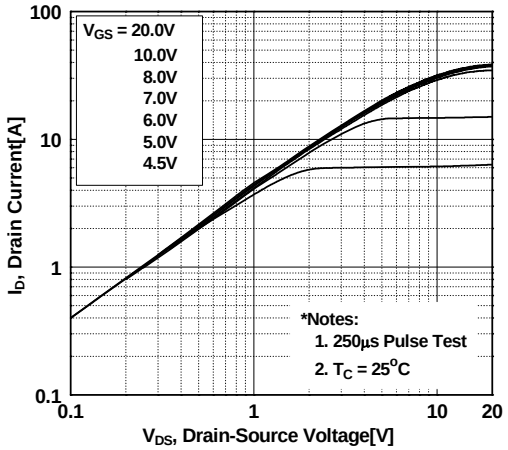


Figure 2. Transfer Characteristics

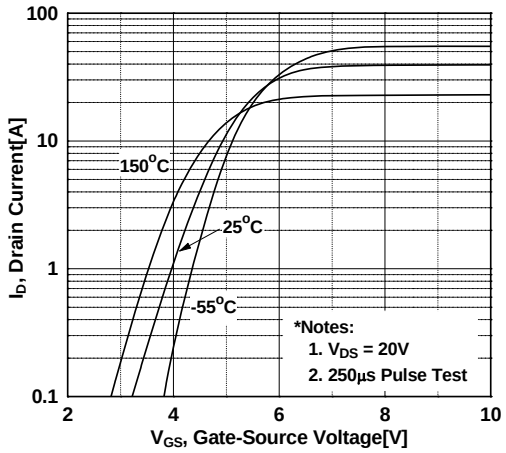


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

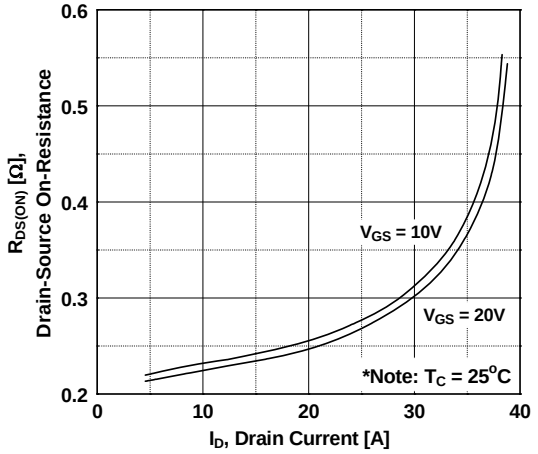


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

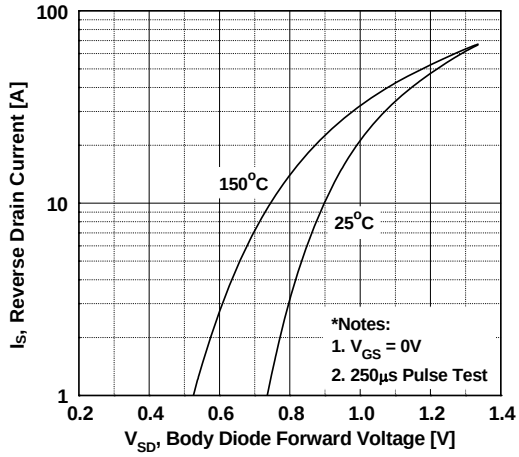


Figure 5. Capacitance Characteristics

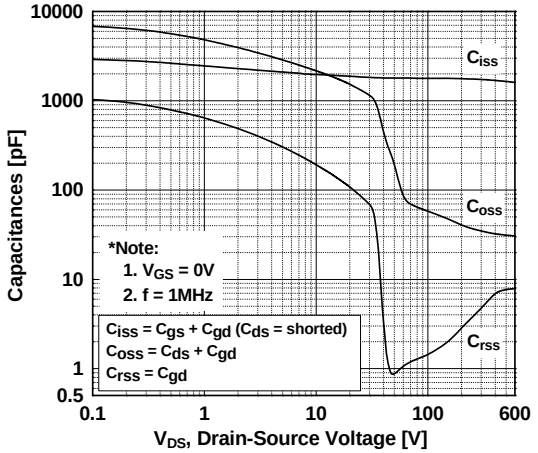


Figure 6. Gate Charge Characteristics